

# SMD Schottky Barrier Diode

**COMCHIP**  
SMD Diodes Specialist

## CDBFR0145(RoHs Device)

**I<sub>o</sub> = 100 mA**

**V<sub>R</sub> = 45 Volts**



### Features

Designed for mounting on small surface.

Extremely thin/leadless package.

Low leakage current.  
(I<sub>R</sub>=0.1uA typ.@V<sub>R</sub>=10V)

Majority carrier conduction.

### Mechanical data

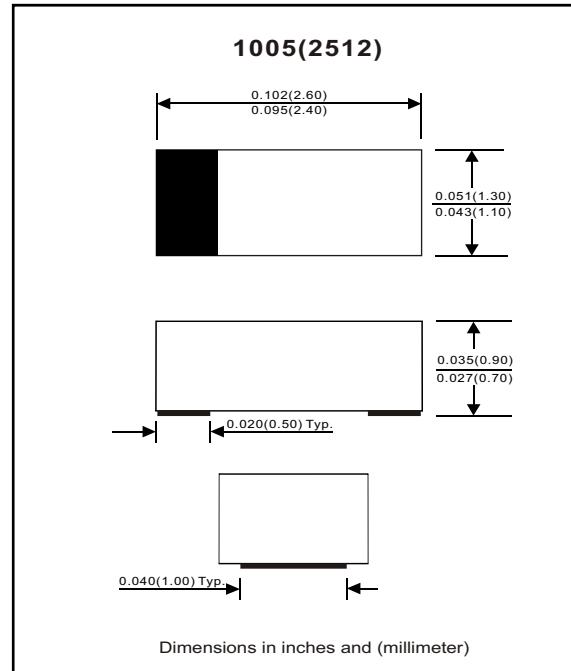
Case: 1005(2512) standard package,  
molded plastic.

Terminals: Gold plated, solderable per  
MIL-STD-750, method 2026.

Polarity: Indicated by cathode band.

Mounting position: Any

Weight: 0.006 gram(approx.).



### Maximum Rating (at TA=25°C unless otherwise noted)

Parameter	Conditions	Symbol	Min	Typ	Max	Unit
Repetitive peak reverse voltage		V <sub>RRM</sub>			50	V
Reverse voltage		V <sub>R</sub>			45	V
Average forward current		I <sub>o</sub>			100	mA
Forward current,surge peak	8.3 ms single half sine-wave superimposed on rate load(JEDEC method)	I <sub>FSM</sub>		1000		mA
Power Dissipation		P <sub>D</sub>			250	mW
Sunction temperature		T <sub>TSG</sub>	-40		+125	°C
Junction temperature		T <sub>j</sub>			+125	°C

### Electrical Characteristics (at TA=25°C unless otherwise noted)

Parameter	Conditions	Symbol	Min	Typ	Max	Unit
Forward voltage	I <sub>F</sub> = 100 mA DC	V <sub>F</sub>			0.55	V
Reverse current	V <sub>R</sub> = 10V	I <sub>R</sub>			1	uA
Capacitance between terimnals	F = 1 MHZ and 10 VDC reverse voltage	C <sub>T</sub>		9		pF

## RATING AND CHARACTERISTIC CURVES (CDBFR0145)

Fig. 1 - Forward characteristics

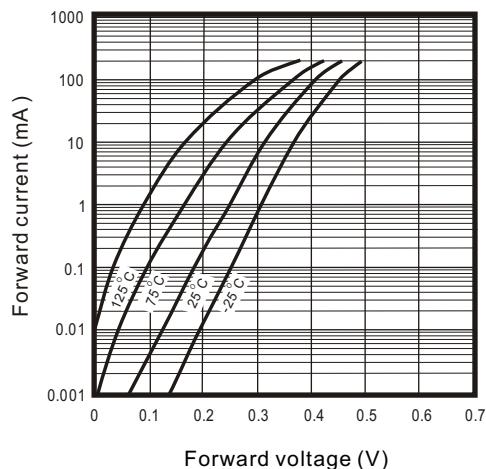


Fig. 2 - Reverse characteristics

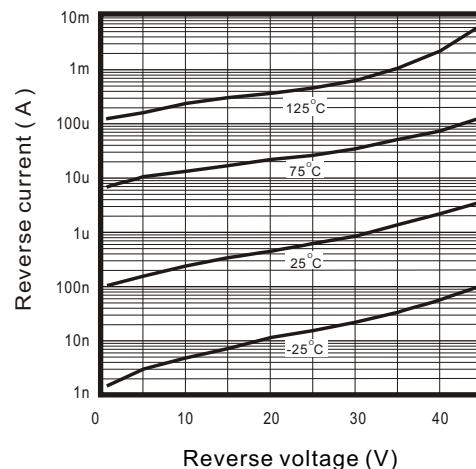


Fig.3 - Capacitance between terminals characteristics

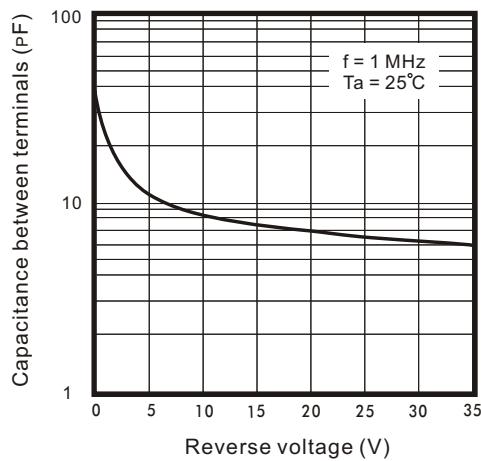


Fig.4 - Current derating curve

